

# RENESAS SEMICONDUCTOR RELIABILITY REPORT

GROUP : RA2L2  
DEVICE : R7FA2L2XXX  
APPLICATION : Consumer / Industry

Quality Assurance Div.  
Renesas Electronics Corporation

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**Table. Reliability test results (QFP)**

Test Items	Reference	Test Conditions	Results Failure/Size	Comment
High Temperature Operating Life (HTOL)	JESD22-A108	Ta=125 °C, Vccmax, 1000 hrs	0/22	
High Temperature Storage Life (HTSL)	JESD22-A103	Ta=150 °C, 1000 hrs	0/22	
Temperature Humidity bias (THB) (*1)	JESD22-A101	Ta=85 °C, RH=85 %, Vccmax, 1000 hrs	0/22	
Temperature Cycling (TC) (*1)	JESD22-A104	Ta=-65 °C to 150 °C , 300 cycles	0/22	
Latch-Up (LU)	JESD78	Pulse Current Injection, I=+/-150 mA	0/3	
Electrostatic discharge (ESD-HBM)	JS-001	1.5 kΩ, 100 pF, +/-2000 V, 1 time	0/3	Class: 2
Electrostatic discharge (ESD-CDM)	JS-002	+/-500V,1time	0/3	Class: C2a
Solderability (SD)	J-STD-002	245 °C, 5 s, Solder coverage ≥95 %	0/5	
Resistance to Soldering Heat (PC)	JESD22-A113, J-STD-020	MSL3(Moisture Sensitivity Level 3)	0/22	

\*1) With preconditioning per JESD22-A113, MSL 3

•It is tested to confirm that all the samples are satisfied with an individual product specification.

Note :

Basically qualification tests were performed using a representative product with the same wafer process and the same package structure .

**Table. Reliability test results (QFN)**

Test Items	Reference	Test Conditions	Results Failure/Size	Comment
High Temperature Operating Life (HTOL)	JESD22-A108	Ta=125 °C, Vccmax, 1000 hrs	0/22	
High Temperature Storage Life (HTSL)	JESD22-A103	Ta=150 °C, 1000 hrs	0/22	
Temperature Humidity bias (THB) (*1)	JESD22-A101	Ta=85 °C, RH=85 %, Vccmax, 1000 hrs	0/22	
Temperature Cycling (TC) (*1)	JESD22-A104	Ta=-65 °C to 150 °C , 300 cycles	0/22	
Latch-Up (LU)	JESD78	Pulse Current Injection, I=+/-150 mA	0/3	
Electrostatic discharge (ESD-HBM)	JS-001	1.5 kΩ, 100 pF, +/-2000 V, 1 time	0/3	Class: 2
Electrostatic discharge (ESD-CDM)	JS-002	+/-500V,1time	0/3	Class: C2a
Solderability (SD)	J-STD-002	245 °C, 5 s, Solder coverage ≥95 %	0/5	
Resistance to Soldering Heat (PC)	JESD22-A113, J-STD-020	MSL3(Moisture Sensitivity Level 3)	0/22	

\*1) With preconditioning per JESD22-A113, MSL 3

•It is tested to confirm that all the samples are satisfied with an individual product specification.

Note :

Basically qualification tests were performed using a representative product with the same wafer process and the same package structure .

The failure rate of the device in an actual use condition can be estimated by the below procedure.

**•Equation for the failure rate estimation ( $\lambda$ )**

$$\lambda = \lambda_b \times \pi T \text{ (FIT)}$$

① Unique failure rate ( $\lambda_b$ )

$$\lambda_b = 4.1 \text{ FIT}$$

Unique failure rate at  $T_a = 55 \text{ }^\circ\text{C}$  using 60 % confidence level.

② Temperature term ( $\pi T$ )

$$\pi T = \exp\{11600 \times E_a \times (1/(273+55) - 1/(273+T_a))\}$$

$E_a$  : Activation energy (eV)

$T_a$  : Ambient temperature ( $^\circ\text{C}$ )

$\pi T$ simplified chart as $E_a = 0.7 \text{ eV}$												
$T_a$ ( $^\circ\text{C}$ )	40	50	55	60	65	70	75	80	85	90	100	110
$\pi T$	0.31	0.68	1	1.45	2.08	2.95	4.15	5.77	7.96	10.88	19.82	34.99

**•MTTF ( Mean Time To Failure )**

$$MTTF = 1/\lambda$$

## Reference about Renesas package code

Package type		Package code *1
Lead type plastic package	QFP	PxQP
	SOP	PxSP
Non-lead type plastic package	QFN	PxQN
Grid array type plastic package	BGA	PxBG
	LGA	PxLG
Wafer level chip scale package	WLCSP	SxBG

\*1. First four digit

Table. Product list

No	Group	Product part number	Package code	No	Group	Product part number	Package code
1	RA2L2	R7FA2L2073CFJ	PLQP0032G*	51			
2	RA2L2	R7FA2L2074CFJ	PLQP0032G*	52			
3	RA2L2	R7FA2L2093CFJ	PLQP0032G*	53			
4	RA2L2	R7FA2L2094CFJ	PLQP0032G*	54			
5	RA2L2	R7FA2L2073CFL	PLQP0048K*	55			
6	RA2L2	R7FA2L2074CFL	PLQP0048K*	56			
7	RA2L2	R7FA2L2093CFL	PLQP0048K*	57			
8	RA2L2	R7FA2L2094CFL	PLQP0048K*	58			
9	RA2L2	R7FA2L2073CFM	PLQP0064K*	59			
10	RA2L2	R7FA2L2074CFM	PLQP0064K*	60			
11	RA2L2	R7FA2L2093CFM	PLQP0064K*	61			
12	RA2L2	R7FA2L2094CFM	PLQP0064K*	62			
13	RA2L2	R7FA2L2073CNE	PWQN0048K*	63			
14	RA2L2	R7FA2L2074CNE	PWQN0048K*	64			
15	RA2L2	R7FA2L2093CNE	PWQN0048K*	65			
16	RA2L2	R7FA2L2094CNE	PWQN0048K*	66			
17	RA2L2	R7FA2L2073CNH	PWQN0032K*	67			
18	RA2L2	R7FA2L2074CNH	PWQN0032K*	68			
19	RA2L2	R7FA2L2093CNH	PWQN0032K*	69			
20	RA2L2	R7FA2L2094CNH	PWQN0032K*	70			
21				71			
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